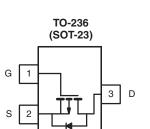


VS2522AL-VB Datasheet

P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^{a, e}	Q _g (Typ.)			
- 30	0.060 at V _{GS} = - 10 V	- 5.0	7 nC			
	0.075 at $V_{GS} = -4.5 \text{ V}$	- 4.6	7110			



FEATURES

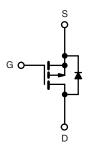
- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET
- 100 % R_g Tested
 Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switch
- Notebook Adaptor Switch
- DC/DC Converter



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	- 30	V	
Gate-Source Voltage		V_{GS}	± 20	V	
	T _C = 25 °C	- I _D	- 5.0		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C		- 4.7		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		- 4.2 ^{b, c}		
	T _A = 70 °C		- 3.3 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	- 25		
Continous Source-Drain Diode Current	T _C = 25 °C	I _S	- 2.1		
	T _A = 25 °C		- 1 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C	P _D	2.5		
	T _C = 70 °C		1.6	10/	
	T _A = 25 °C		1.25 ^{b, c}	W	
	T _A = 70 °C	1	0.8 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	75	100	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50		

Notes:

- a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under Steady State conditions is 166 °C/W.
- e. Package Limited.



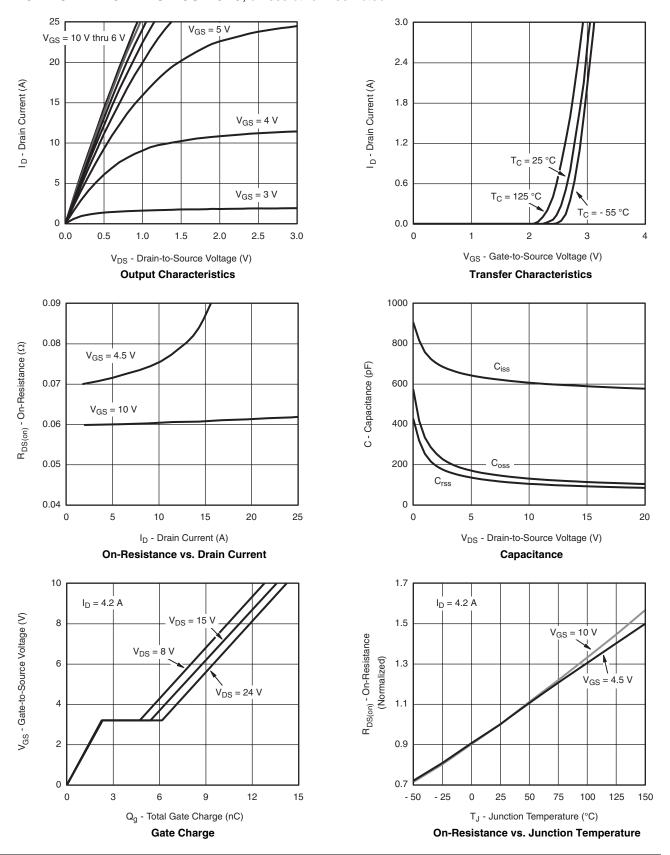
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 vA		- 19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	- 1.0		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μΑ	
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α	
Drain-Source On-State Resistance ^a	, ,	V _{GS} = - 10 V, I _D = - 4.2 A		0.060		+ -	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.2 A		0.075		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 4.2 A		10		S	
Dynamic ^b							
Input Capacitance	C _{iss}			590			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		115		pF	
Reverse Transfer Capacitance	C _{rss}			93			
<u>'</u>	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 4.2 A		13.6	21	nC	
Total Gate Charge		20 × 30 × 5		7	11		
Gate-Source Charge	Q_{gs}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 4.2 A		2.3			
Gate-Drain Charge	Q _{gd}	1		3.2			
Gate Resistance	R_{g}	f = 1 MHz	1	5	10	Ω	
Turn-On Delay Time	t _{d(on)}			30	45	ns	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 4.5 \Omega$		25	38		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.3 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		16	24		
Fall Time	t _f	1		8	16		
Turn-On Delay Time	t _{d(on)}			8	16		
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 4.5 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -3.3 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		18	27		
Fall Time	t _f	1		8	16		
Drain-Source Body Diode Characteristi	cs			<u>I</u>	<u>I</u>	ı	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.2		
Pulse Diode Forward Current	I _{SM}				- 25	A	
Body Diode Voltage	V_{SD}	I _S = - 3.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	I _F = - 3.3 A, dI/dt = 100 A/μs, T _J = 25 °C		17	26	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			9	18	nC	
Reverse Recovery Fall Time	t _a			10			
Reverse Recovery Rise Time	t _b	1		7		ns	

2

服务热线:400-655-8788

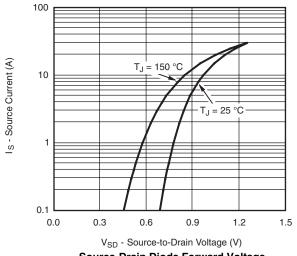
Notes: a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



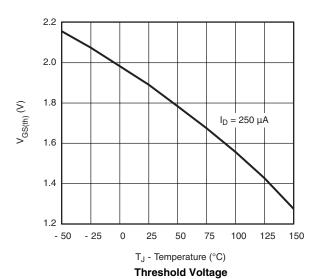


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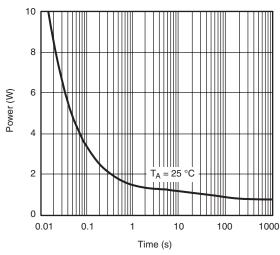




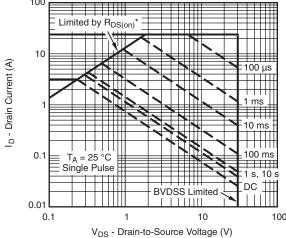


0.10 $I_D = 4.2 A$ R_{DS(on)} - On-Resistance (Ω) 0.08 $T_J = 125~^{\circ}C$ 0.06 $T_J = 25$ °C 0.04 0.02 2

V_{GS} - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

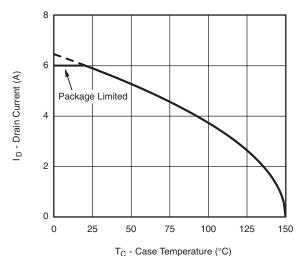


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

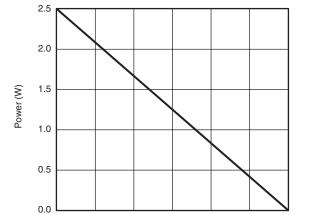
Safe Operating Area, Junction-to-Ambient

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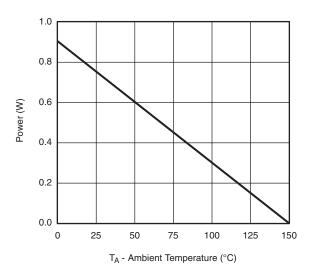
Current Derating*





75

100



Power, Junction-to-Ambient

150

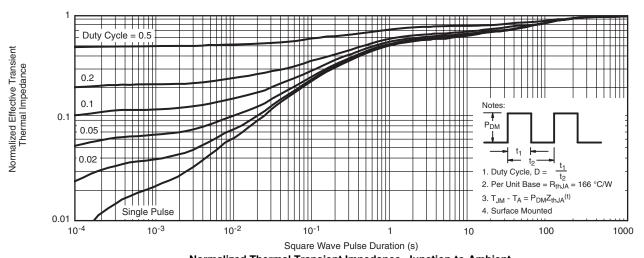
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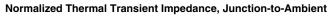
0

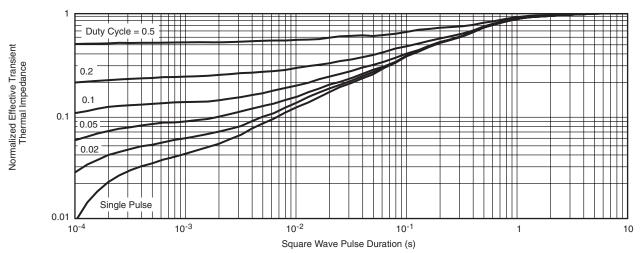
25

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.









Normalized Thermal Transient Impedance, Junction-to-Foot



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